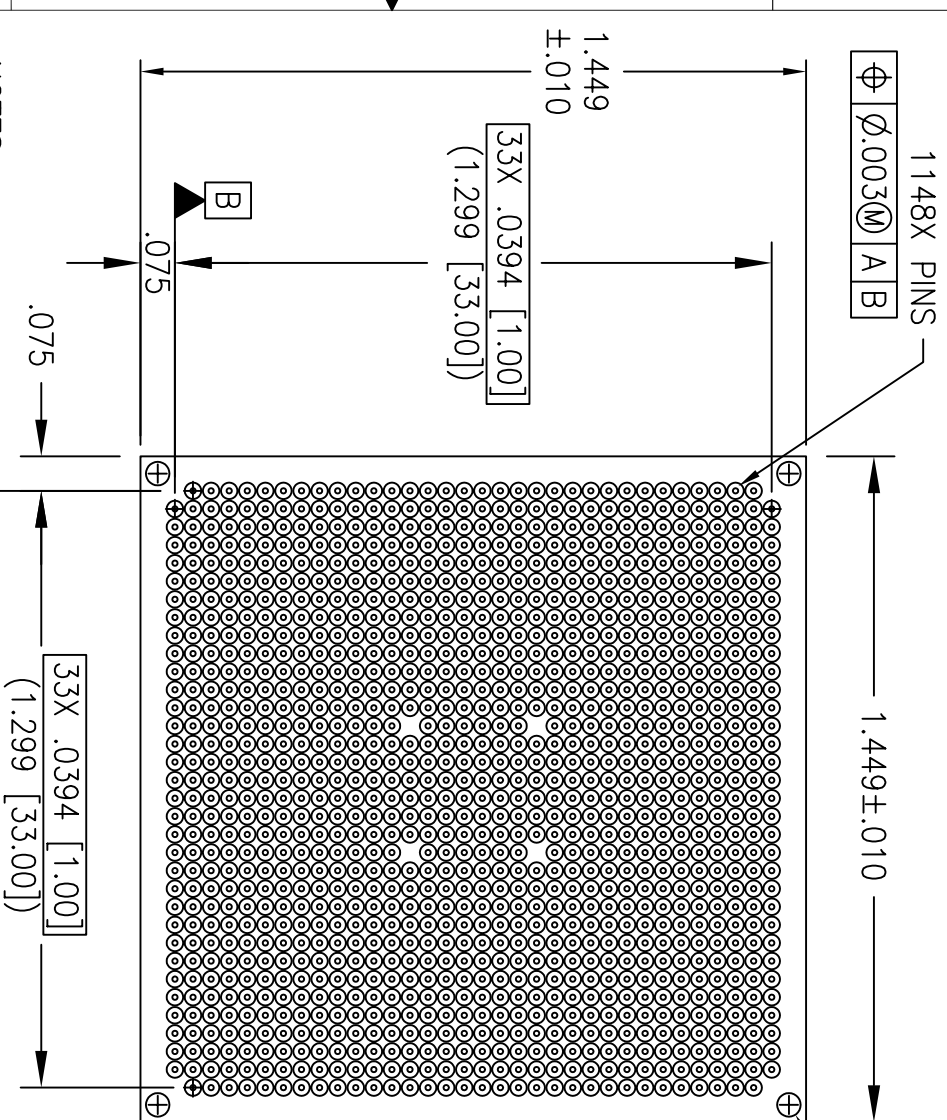
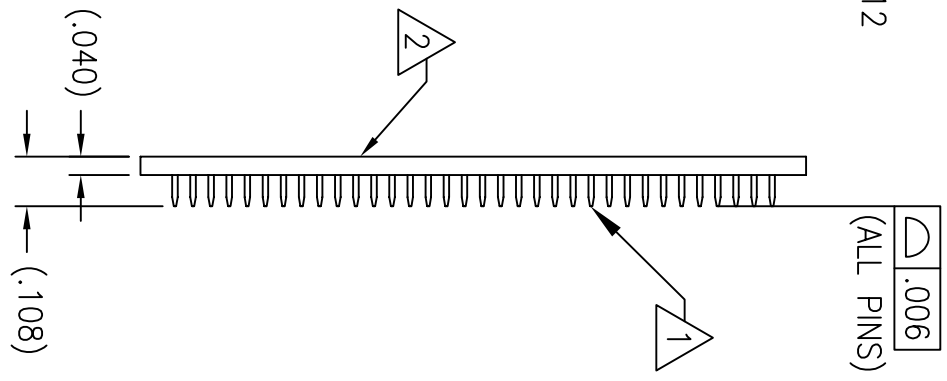


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TOP VIEW



RS VIEW



REV	DESCRIPTION	EGN	DATE	RELEASE
1	SALES RELEASE			

- 1. PINS  $\phi$ .0117
- MATERIAL: PHOSPHOR BRONZE.
- PLATING: HARD GOLD OVER NICKEL.

2. INSULATOR MATERIAL: FR4.

NOTES:

UNLESS OTHERWISE SPECIFIED: DIMENSIONS ARE IN INCHES TOLERANCES: ANGLES: FRACTIONS: DECIMALS: .XXX ±.005 .XXXX ±.0005

CONTRACT NO.		DRAWN BY		DATE	
DESIGNER		CHECKER		DATE	
DATE		DATE		DATE	
TITLE		SCALE		DRAWING NO.	
HIL0-BGA PIN BASE		N/A		HLP-341148-B-10	
134 X 34, 1148 PINS		1mm PITCH		FINISHED ASST: HLP-341148-B-10	
708 VIA ALONDRA, CAMARILLO, CA 93012		SHEET 1 OF 1		REV 1	

ASIZE 4 3 2 1